Meeting the MIL-STD Space Level Hermetic Test Requirements with Optical Leak Testing (OLT)

CSME Conference



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Candidate Technologies for Hermetic Inspection to Current MIL-STD 750 and MIL-STD 883 Space Level Leak Rates

- Helium Mass Spectrometry, HMS (Fine only)
- Bubble Leak testing (Gross only)
- Optical Leak Testing, OLT (Fine and Gross)
- High Sensitivity Helium Leak Detection System, HSHLD (Fine and Gross)
- Krypton (85 Fine and Dry or Wet Test Gross)
- Cumulative Helium Leak Detection (Fine and Gross)



Non-Space vs Space Reject limits

MIL-STD-883K

3. <u>FAILURE CRITERIA</u>. Unless otherwise specified, any device tested for Fine Leak that exhibits a leakage rate equal to or greater than the test limits of table VII shall be considered a failure.

Internal Free Volume of package (cm ³)	L Failure Criteria atm-cm ³ /sec (air)	L Failure Criteria atm-cm ³ /sec (air)
	Hybrid Class H, and Monolithic Classes B, S, Q and V	Hybrid Class K only
≤ 0.05	5 X10⁻ ⁸	1 X 10 ⁻⁹
>0.05 - ≤ 0.4	1 X 10 ⁻⁷	5 X 10 ⁻⁹
> 0.4	1 X 10 ⁻⁶	1 X 10 ⁻⁸

TABLE VII. Test limits for all fine leak methods. 1/ 2/



Space reject limits about 100X to 50X smaller.

- OLT usually tests space limits in 0.3 to 3 hours.
 - HMS usually requires 100 to 200 hours of bomb time



HMS not Practical for Space Limits

TABLE I. Fixed conditions for condition A1.												
V Internal Free	Bomb Condition Hybrid Class H and Monolithic Classes B, Q, S and V						Bomb Condition Hybrid Class K					
package (cm ³)	Psia ±2 <u>1/</u>	t ₁ Minimum exposure time (hrs)	t₂ Max Dwell time (hrs) <u>2</u> /	R1 Reject Limit (atm-cm ³ /s) He	L Equivalent Leak rate (atm-cm ³ /s) air		Psia ±2 <u>1/</u>	t ₁ Minimum exposure time (hrs)	t ₂ Max Dwell time (hrs) <u>2</u> /	R1 Reject Limit (atm- cm ³ /s) He	L Equivalent Leak rate (atm- cm ³ /s) air	
>0.4 ≤1.0	30 30 45 45	0.5 1.0 0.5 1.0	1	2.6 X 10 ⁻⁸ 5.2 X 10 ⁻⁸ 3.9 X 10 ⁻⁸ 7.8 X 10 ⁻⁸			30 30 45 45	2.0 9.5 1.5 6.5	1	1.1 X 10 ⁻¹¹ 5.0 X 10 ⁻¹¹ 1.2 X 10 ⁻¹¹ 5.1 X 10 ⁻¹¹		
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•Above table for HMS, A₁, fixed conditions MIL-STD-883K.

- Why does Class K, go to 1e-11 R, when Class H to 1e-9 R?
- Most HMS systems typically can only sense 1e-9 R.
- If 1e-9 R was used for Class K, Space Levels, then t₁ exposure time would be 100 to 200 hours.



Technical Issues with HMS and Bubble Leak Testing to Class K Space Limits

- Long helium bomb cycle times, usually 100 plus hours.
- Two helium bomb cycles.
 - One for HMS, another for bubble leak testing.
- HMS can not test at the board level.
- Gap in test coverage in the 1x10⁻⁵ cc-atm/sec range.
- Helium absorption by package causes false failures.
 - Typical problem with fiber optic cables attached.
- Product contamination by fluids during bubble testing.
- Bubble leak testing very operator dependent.
 - Possible to miss bubbles in a large tank, so leaking devices can escape.







Typical Hermetic Package Styles







Pacemakers



Display Devices



Hybrids

Frequency Control





Fiber Optics



Quartz Crystals

Custom



TO Styles



Power Devices

Sources of Leaks in Packages

Along the weld



A defect in the lid or housing







At the glass to metal feed through



- Uses a phased stepped holographic interferometer to monitor the package lid deflection under pressure and determines how much a package is leaking
- Allows gross and fine leak inspection in one test
- Results in shorter test times by eliminating Helium bombing cycle
- Batch inspection on up to 500 devices in one test



Optical Leak Test continued

•Outputs results in L_{air} or L_{He} cc-atm/sec.

Reject limits in MIL-STD-883K are L_{air}
OLT directly measures in L_{air}.

 Tests packages mounted to a circuit board or substrate



Theory Leaking vs Hermetic

"

- Side view of package.
- Chamber pressure causes lid to bow down "



Test gas rushes in on a leaking package to push lid
 up.



•Test gas can not get into sealed package to move lid.

Theory with Visible Hole



- Test gas rushes in through visible hole so lid stays flat.
- Add pressure modulation to measure spring rate of lid.
- Above lid stiffness is 0 um/psi. Hermetic > -0.02 um/psi.



• Typical pressure modulation for butterfly package with lid stiffness – 1um/psi.

Interference Fringes

- Fringe is short for Interference Fringe.
- Definition by britannica.com.
 - A bright or dark band caused by beams of light in phase or out of phase. Light waves will add their crests if they meet in the same phase (bright band). The troughs will cancel the crests if they are out of phase (dark band).
- Similar to dropping a pebble in water.



Live video fringe of package with changing pressure

Phase map showing fringes on leaking device



Laser Interferometer Phase Maps



System Operation



Butterfly devices with fiber optics in tray

Operator places tray into system and closes chamber door.



Test Report



True Leak Rate "L" by OLT



- Assume a flow meter inside a pressure chamber with a hose hooked up to a leak on the weld on the lid.
- The flow meter would measure "L" or true leak rate as OLT (optical leak testing) does.

Tracer Gas Leak Rate "R" by HMS

Step 1: Bomb with helium

Step 2: Measure helium escaping



- Bomb package with helium for many hours.
- Move package to vacuum chamber with proper sensor to measure "R".

R versus L Type of Leak Rate

IABLE I. Fixed conditions for condition A ₁ .											
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				100						1,0	00 X

Above useful to show difference between R & L.

- Shows R₁ or tracer gas leak rate for HMS.
 - is 100 to 1,000 smaller.
 - than L or true leak rate for OLT.



OLT Measures Directly in Lair

- •Table VII in MIL-STD-883K is proper table for reject limits, which are in ${\sf L}_{\rm air}$.
- HMS uses Howl Mann equation to convert R to L.
- OLT can directly measure L_{air} with air.
- L_{air} is more useful in calculating exchange rates for turnover of internal atmosphere.
 - Aids calculation of reject limit for specific application.
- While R and L_{he} both use helium
 - and have the same units: atm-cc/sec
 R is 100 to 1,000 bigger for the same flow rate.



OLT Test Sensitivity

Recent test on wafer level device.

- 24 hours, 64 psig, 0.01 cc,
- stiffness -0.05 um/psi.
- $L_{he} = 1.04 \times 10^{-10}$ cc-atm/sec (actual)
- $L_{air} = 3.87 \times 10^{-11}$ cc-atm/sec (calculated)
- $R_1 = 3.93 \times 10^{-14}$ cc-atm/sec (calculated)



Typical Optical Leak Test System



Testing Board Mounted Devices





- Hermetic devices may fail during board assembly due to high temperature soldering process.
- Optical Leak Testing is not subject to gas absorption issues, so can test devices on assembled circuit boards.
- Since boards usually absorbs helium, HMS can be problematic.

Wafer Level MEMs Testing



Cavity size is 5 mm square.

Recent OLT Applications

- A recent lot of 50 packages were tested by a Company with conventional bubble leak for gross and HMS for fine and all 50 passed.
- The packages were then tested with OLT and 1 out
 50 was found to be a gross leaking device.



OLT Testing at Class K Levels



Study with TO-257 showed excellent correlation between Kr85 and OLT.

S/N	374	277	23	372	290	203	131	134	3	53	364	36
Kr85 L _{air}	8.20E-09	6.70E-09	2.00E-08	4.80E-08	3.40E-08	3.90E-08	6.80E-08	1.70E-07	2.45E-07	2.18E-07	2.40E-07	2.90E-07
OLT L _{He}	2.00E-09	8.90E-09	1.90E-08	3.00E-08	1.70E-08	4.70E-08	8.80E-08	1.80E-07	2.20E-07	2.20E-07	2.50E-07	3.20E-07

Optical Leak Testing History MIL-STD 883

Included into Mil-STD-883 Method 1014 in 1995
 Updated in 2004 in 2004 for Gross and Fine leak

- testing on both individual components and circuit board level testing
 - The system outputs true leak rate instead of lid deflection
 - Leaking device samples are no longer needed for calibration and set up
- Revision K draft was published in April 2016
 - Failure criteria and test methodology is better defined

Presentation Contact

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